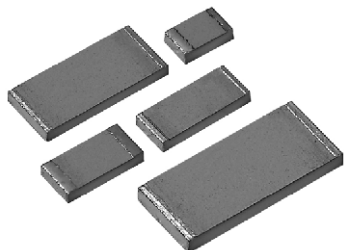




Ultra High Precision Foil Wraparound Surface Mount Chip Resistor with TCR of $\pm 0.05 \text{ ppm/}^\circ\text{C}$ and Power Coefficient of 5 ppm at Rated Power and Load Life Stability of $\pm 0.005 \%$ (50 ppm)



Top View

INTRODUCTION

VSMF Series is the industry's first device to provide high rated power, excellent load life stability along with extremely low TCR all in one resistor.

One of the most important parameters influencing stability is the temperature coefficient of resistance (TCR). Although the TCR of foil resistors is considered extremely low, this characteristic has been further refined over the years. The VSMF Series utilizes ultra high precision Bulk Metal® Z-foil. The Z-foil technology provides a significant reduction of the resistive element's sensitivity to ambient temperature variations (TCR) and to self heating when power is applied (power coefficient). Along with the inherently low PCR and TCR, Z-foil technology also provides remarkably improved load life stability, low noise and availability of tight tolerance.

The VSMF has a full wraparound termination which ensures safe handling during the manufacturing process, as well as providing stability during multiple thermal cyclings.

Our application engineering department is available to advise and make recommendations. For non-standard technical requirements and special applications, please contact us using the e-mail address in the footer below.

TABLE 1 - TOLERANCE AND TCR VS. RESISTANCE VALUE (1)

(- 55 °C to + 125 °C, + 25 °C Ref.)

RESISTANCE VALUE (Ω)	TOLERANCE (%)	TYPICAL TCR AND MAX. SPREAD (ppm/°C)
250 to 150K	± 0.01	± 0.2 ± 1.8
100 to < 250	± 0.02	± 0.2 ± 1.8
50 to < 100	± 0.05	± 0.2 ± 2.8
25 to < 50	± 0.1	± 0.2 ± 3.8
10 to < 25	± 0.25	± 0.2 ± 3.8

Note

(1) For tighter performances, please contact Vishay application engineering using the e-mail addresses in the footer below.

FEATURES

- Temperature coefficient of resistance (TCR):
0.05 ppm/°C typical (0 °C to + 60 °C)
0.2 ppm/°C typical (- 55 °C to + 125 °C, + 25 °C ref.)
- Tolerance: to ± 0.01 %
- Power coefficient "ΔR due to self heating":
5 ppm at rated power
- Power rating: to 750 mW at + 70 °C
- Load life stability: to ± 0.005 % at 70 °C, 2000 h at rated power
- Resistance range: 10 Ω to 150 kΩ (for higher and lower values, please contact us)
- Vishay Foil resistors are not restricted to standard values, we can supply specific "as required" values at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Fast thermal stabilization < 1 s
- **Electrostatic discharge (ESD) up to 25 000 V**
- Short time overload: ≤ 0.005 %
- Non inductive, non capacitive design
- Rise time: 1 ns effectively no ringing
- Current noise: - 42 dB
- Voltage coefficient < 0.1 ppm/V
- Non inductive: < 0.08 μH
- Non hot spot design
- Terminal finishes available: lead (Pb)-free tin/lead alloy
- Matched sets are available on request
- Prototype samples available from 72 h. For more information, please contact foil@vishay.com
- For better performances please contact us

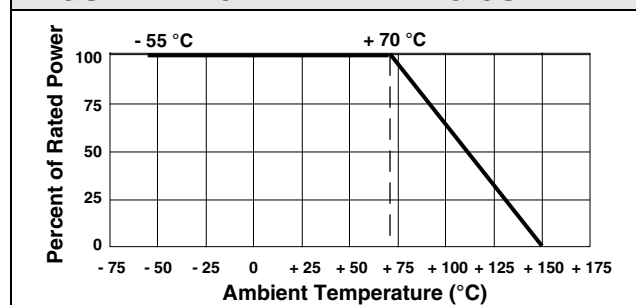


RoHS*
COMPLIANT

APPLICATIONS

- Automatic test equipment (ATE)
- High precision instrumentation
- Laboratory, industrial and medical
- Audio
- EB applications (electron beam scanning and recording equipment, electron microscopes)
- Down hole instrumentation
- Communication

FIGURE 1 - POWER DERATING CURVE



* Pb containing terminations are not RoHS compliant, exemptions may apply

FIGURE 2 - TRIMMING TO VALUES

(Conceptual Illustration)

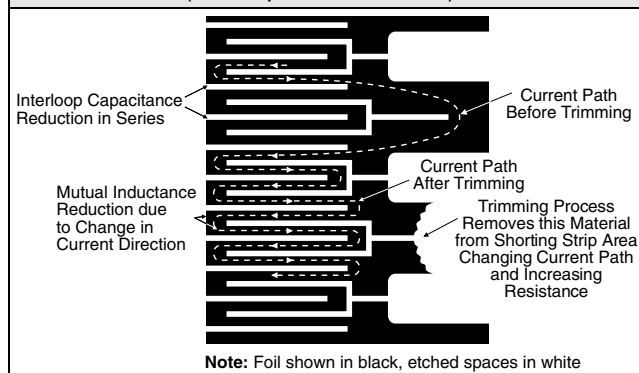
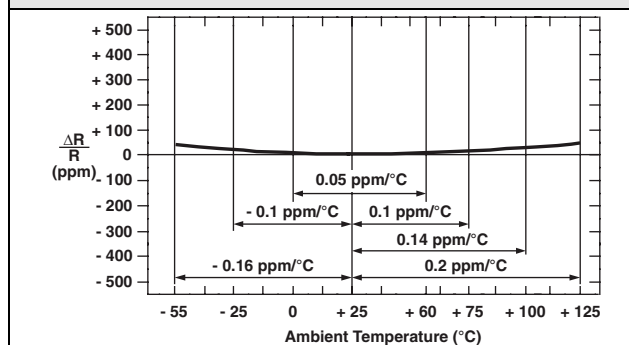


FIGURE 3 - TYPICAL TCR CURVE Z-FOIL



Note

- The TCR values for $< 100 \Omega$ are influenced by the termination composition and result in deviation from this curve.

TABLE 2 - DIMENSIONS AND LAND PATTERN in Inches (Millimeters)

Top View				Recommended Land Pattern			
CHIP SIZE	L ± 0.005 (0.13)	W ± 0.005 (0.13)	THICKNESS MAXIMUM	D ± 0.005 (0.13)	Z ⁽¹⁾ MAXIMUM	G ⁽¹⁾ MINIMUM	X ⁽¹⁾ MAXIMUM
0805	0.080 (2.03)	0.050 (1.27)	0.025 (0.64)	0.015 (0.38)	0.122 (3.10)	0.028 (0.71)	0.050 (1.27)
1206	0.126 (3.20)	0.062 (1.57)	0.025 (0.64)	0.020 (0.51)	0.175 (4.45)	0.059 (1.50)	0.071 (1.80)
1506	0.150 (3.81)	0.062 (1.57)	0.025 (0.64)	0.020 (0.51)	0.199 (5.05)	0.083 (2.11)	0.071 (1.80)
2010	0.198 (5.03)	0.097 (2.46)	0.025 (0.64)	0.025 (0.64)	0.247 (6.27)	0.115 (2.92)	0.103 (2.62)
2512	0.249 (6.32)	0.127 (3.23)	0.025 (0.64)	0.032 (0.81)	0.291 (7.39)	0.150 (3.81)	0.127 (3.23)

Note

⁽¹⁾ Land Pattern Dimensions are per IPC-7351A

TABLE 3 - SPECIFICATIONS

CHIP SIZE	RATED POWER (mW) at + 70 °C	MAX VOLTAGE RATING ($\leq \sqrt{P \times R}$)	RESISTANCE RANGE (Ω)	MAXIMUM WEIGHT (mg)
0805	200	49 V	10 to 12K	6
1206	300	95 V	10 to 30K	11
1506	300	110 V	10 to 40K	12
2010	500	200 V	10 to 100K	27
2512	750	220 V	10 to 150K	40

TABLE 4 - LOAD LIFE STABILITY
(+ 70 °C for 2000 h)

CHIP SIZE	MAXIMUM ΔR LIMITS
0805	± 0.005 % at 100 mW ± 0.01 % at 200 mW
1206, 1506	± 0.005 % at 150 mW ± 0.01 % at 300 mW
2010	± 0.005 % at 200 mW ± 0.01 % at 500 mW
2512	± 0.005 % at 500 mW ± 0.01 % at 750 mW

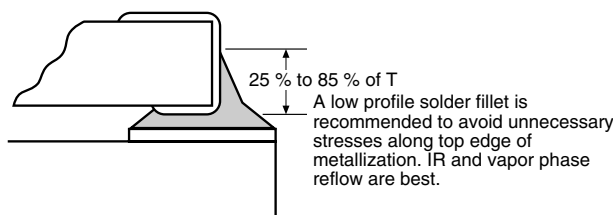
TABLE 5 - PERFORMANCES

TEST OR CONDITIONS	MIL-PRF-55342 CHARACTERISTIC E ΔR LIMITS	TYPICAL ΔR LIMITS	MAXIMUM ΔR LIMITS ⁽¹⁾
Thermal shock	± 0.1 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
Low temperature operation	± 0.1 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
Short time overload	± 0.1 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
High temperature exposure	± 0.1 %	± 0.01 % (100 ppm)	± 0.02 % (200 ppm)
Resistance to soldering heat	± 0.2 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)
Moisture resistance	± 0.2 %	± 0.005 % (50 ppm)	± 0.02 % (200 ppm)
Load life stability + 70 °C for 2000 h at rated power	± 0.5 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)

Note

⁽¹⁾ As shown + 0.01 Ω to allow for measurement errors at low values.

FIGURE 4 - RECOMMENDED MOUNTING (1)(2)(3)

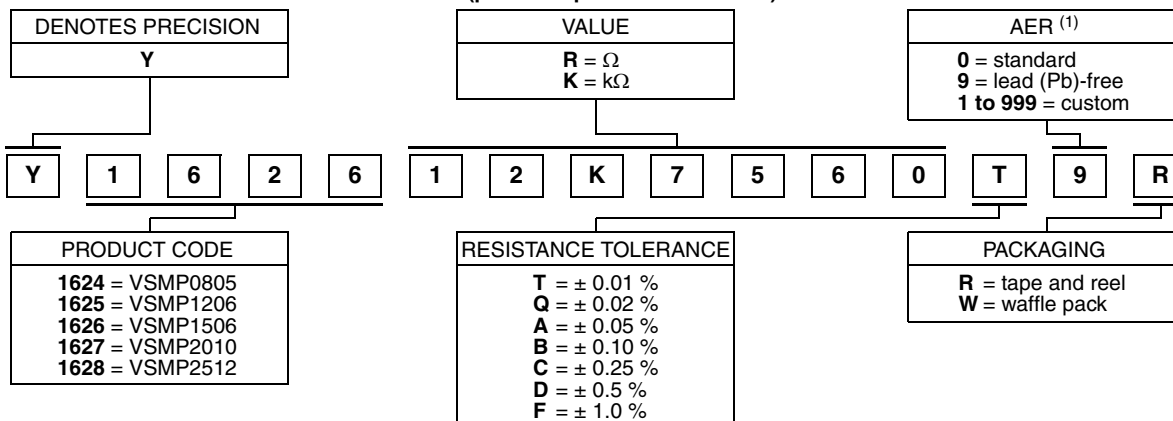


Notes

1. Avoid the use of cleaning agents which could attack epoxy resins, which form part of the resistor construction
2. Vacuum pick up is recommended for handling
3. Soldering iron may damage the resistor

TABLE 6 - GLOBAL PART NUMBER INFORMATION

NEW GLOBAL PART NUMBER: Y162612K7560T9R (preferred part number format)



FOR EXAMPLE: ABOVE GLOBAL ORDER Y1626 12K7560 T 9 R:

TYPE: VSMP1506
VALUES: 12.7560 $k\Omega$
ABSOLUTE TOLERANCE: 0.01 %
TERMINATION: lead (Pb)-free
PACKAGING: tape and reel

HISTORICAL PART NUMBER: VSMP1506 12K756 TCR0.2 T S T (will continue to be used)

VSMP1506	12K756	TCR0.2	T	S	T
MODEL	RESISTANCE VALUE	TCR CHARACTERISTICS	TOLERANCE	TERMINATION	PACKAGING
VSMP0805 VSMP1206 VSMP1506 VSMP2010 VSMP2512	12.756 $k\Omega$		T = $\pm 0.01\%$ Q = $\pm 0.02\%$ A = $\pm 0.05\%$ B = $\pm 0.10\%$ C = $\pm 0.25\%$ D = $\pm 0.5\%$ F = $\pm 1.0\%$	S = lead (Pb)-free B = tin/lead	T = tape and reel W = waffle pack

Note

⁽¹⁾ For non-standard requests, please contact application engineering.



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